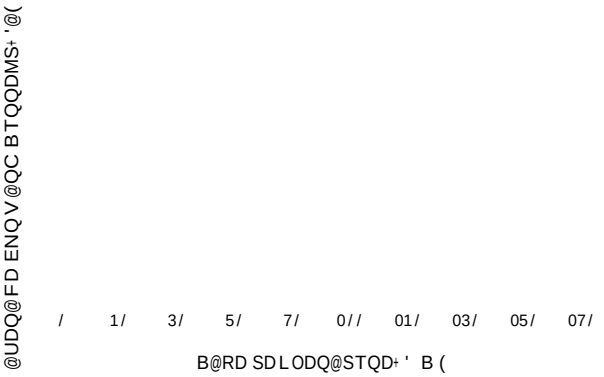
- Glass passivated chip junctions
- Super fast recovery time for switching mode application
- High Forward Surge Capability
- Low Reverse Current
- Lead free in compliance with EU RoHS 2011/65/EU directive

- Circuit figure: Common
- Leads: Solderable per mil-std-202, Method 208
- Polarity:as marked
- Mounting torque:5 in-lbs maximum
- Terminals:Puretin plated

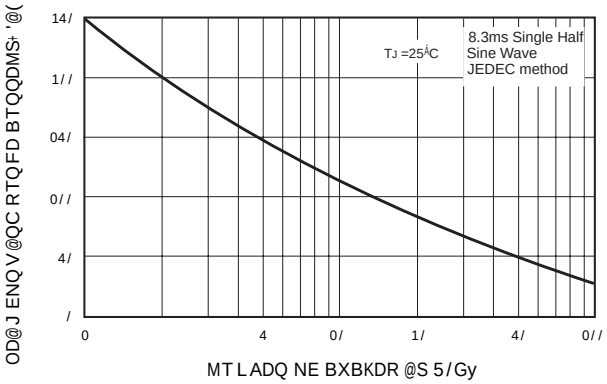
MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (TA=25)

Maximum repetitive reverse voltage	V_{RRM}	400	V
Maximum RMS voltage	V_{RMS}	280	V
Maximum DC blocking voltage	V_D า 2 0 า		

EHF- 0 , SXOHB@K ENQV@QC BTQQDMS CDQ@SHMF BTQUD



EHF- 2 , L@WHLTL MNM,QDODSHSHUD ENQV@QC RTQFD BTQQDMS



EHF- 3 , SXOHB@K QDUDQRD BG@Q@BSDQHRSHBR



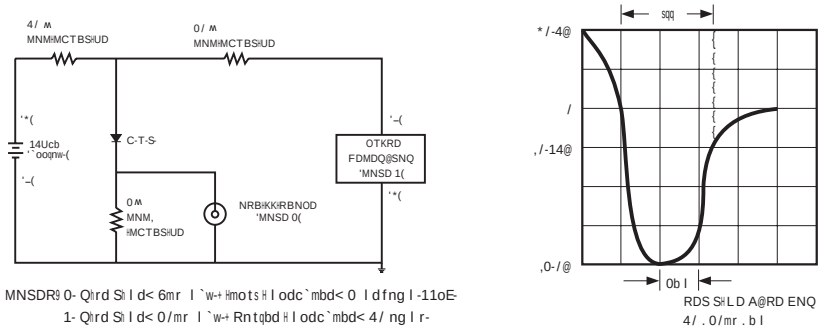
EHF- 1 , SXOHB@K HMRS@MS@MDNTR ENQV@QC BG@Q@BSDQHRSHBR



HMRS@MS@MDNTR ENQV@QC UNKS@FD+ 'U(

ODQBDMS NE Q@SDC OD@J QDUDQRD UNKS@FD+ '$(

EHF-5, SDRS BHQBTHS CH@FQ@L @MC QDUDQRD QDBNUDQX SHLD BG@Q@BSDQHRSHBR



MNSDR% 0- Qhrd Shld< 6mr l `w-+ HmotsH lodc`mbd< 0 ldfng l-11oE-
1- Qhrd Shld< 0/mr l `w-+ RntqbdH lodc`mbd< 4/ng l r-

Marking Diagram

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